Advance Information

Low Voltage 1:18 Clock Distribution Chip

The MPC940 is a 1:18 low voltage clock distribution chip. The device features the capability to select either a differential LVPECL or an LVTTL/LVCMOS compatible input. The 18 outputs are LVCMOS or LVTTL compatible and feature the drive strength to drive 50Ω series or parallel terminated transmission lines. With output–to–output skews of 150ps, the MPC940 is ideal as a clock distribution chip for the most demanding of synchronous systems. For a similar product with a larger number of outputs, please consult the MPC941 data sheet.

- LVPECL or LVCMOS/LVTTL Clock Input
- 150ps Maximum Targeted Output–to–Output Skew
- Drives Up to 36 Independent Clock Lines
- Maximum Output Frequency of 250MHz
- 32-Lead TQFP Packaging
- 3.3V V_{CC} Supply Voltage

With a low output impedance ($\approx 20\Omega$), in both the HIGH and LOW logic states, the output buffers of the MPC940 are ideal for driving series terminated transmission lines. More specifically, each of the 18 MPC940 outputs can drive two series terminated 50Ω transmission lines. With this capability, the MPC940 has an effective fanout of 1:36 in applications where each line drives a single load. With this level of fanout, the MPC940 provides enough copies of low skew clocks for most high performance synchronous systems.

MPC940

LOW VOLTAGE 1:18 CLOCK DISTRIBUTION CHIP



FA SUFFIX 32-LEAD TQFP PACKAGE CASE 873A-02

The differential LVPECL inputs of the MPC940 allow the device to interface directly with a LVPECL fanout buffer like the MC100EP111 to build very wide clock fanout trees or to couple to a high frequency clock source. The LVCMOS/LVTTL input provides a more standard interface for applications requiring only a single clock distribution chip at relatively low frequencies. In addition, the two clock sources can be used to provide for a test clock interface as well as the primary system clock. A logic HIGH on the LVCMOS_CLK_Sel pin will select the TTL level clock input.

The MPC940 is fully 3.3V compatible. The 32-lead TQFP package was chosen to optimize performance, board space and cost of the device. The 32-lead TQFP has a 7x7mm body size with a conservative 0.8mm pin spacing.

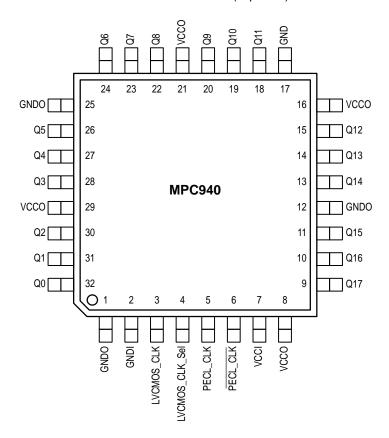
This document contains information on a new product. Specifications and information herein are subject to change without notice.



LOGIC DIAGRAM



Pinout: 32-Lead TQFP (Top View)



FUNCTION TABLE

LVCMOS_CLK_Sel	Input
0	PECL_CLK
1	LVCMOS_CLK

查询"MPC940"供应商 ABSOLUTE MAXIMUM RATINGS*

Symbol	Parameter	Min	Max	Unit
VCC	Supply Voltage	-0.3	3.6	V
VI	Input Voltage	-0.3	V _{DD} + 0.3	V
I _{IN}	Input Current		±20	mA
T _{Stor}	Storage Temperature Range	-40	125	°C

Absolute maximum continuous ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute-maximum-rated conditions is not implied.

DC CHARACTERISTICS (T_A = 0° to 70° C, V_{CC} = $3.3V \pm 5\%$)

Symbol	Characteristic		Min	Тур	Max	Unit	Condition
VIH	Input HIGH Voltage	PECL_CLK Other	2.135 2.0		2.42 3.60	V	
VIL	Input LOW Voltage	PECL_CLK Other	1.49		1.825 0.8	V	
Vpp	Peak-to-Peak Input Voltage	PECL_CLK	300		1000	mV	
VCMR	Common Mode Range	PECL_CLK	V _{CC} -2.0		V _{CC} -0.6	V	
Vон	Output HIGH Voltage		2.5			V	I _{OH} = -16mA, Note 1.
VOL	Output LOW Voltage				0.5	٧	I _{OH} = 16mA, Note 1.
I _{IN}	Input Current				±100	μΑ	
C _{IN}	Input Capacitance				4	pF	
C _{pd}	Power Dissipation Capacitance	·		8		pF	Per Output
Icc	Maximum Quiescent Supply Cu	rrent ICCL		70 140		mA	

^{1.} The MPC940 outputs can drive series or parallel terminated 50Ω (or 50Ω to $V_{CC}/2$) transmission lines on the incident edge.

AC CHARACTERISTICS ($T_A = 0^{\circ}$ to 70° C, $V_{CC} = 3.3$ V $\pm 5\%$)

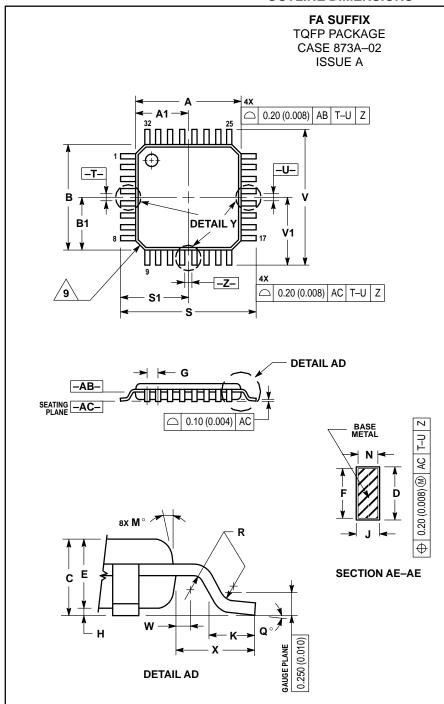
Symbol	Characteri	stic	Min	Тур	Max	Unit	Condition
F _{max}	Maximum Input Frequency	/		250		MHz	Note 1.
^t pd	Propagation Delay	PECL_CLK to Q TTL_CLK to Q		1.7 2.0		ns	Note 1.
t _{sk(o)}	Output-to-Output Skew				150	ps	Note 1.
^t sk(pr)	Part-to-Part Skew	PECL_CLK to Q TTL_CLK to Q		800 800		ps	Notes 2., 3.
t _{pwo}	Output Pulse Width		45		55	р%	Note 1., Measured at V _{CC} /2
t _r , t _f	Output Rise/Fall Time		0.20		1.0	ns	0.8V to 2.0V

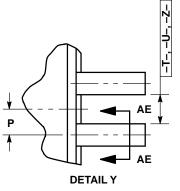
- 1. Driving 50Ω transmission lines
- 2. Part-to-part skew at a given temperature and voltage
- 3. Final specification limits will be determined from matrix lot material. 800ps is the "best estimate" based on initial material and experience with previous products.

3

MOTOROLA

OUTLINE DIMENSIONS





NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

- Y14.5M, 1982.

 2. CONTROLLING DIMENSION: MILLIMETER.

 3. DATUM PLANE -AB- IS LOCATED AT BOTTOM OF LEAD AND IS COINCIDENT WITH THE LEAD WHERE THE LEAD EXITS THE PLASTIC BODY AT THE BOTTOM OF THE PARTING LINE.

 4. DATUMS -T-, -U-, AND -Z- TO BE DETERMINED AT DATUM PLANE -AB-.

 5. DIMENSIONS S AND V TO BE DETERMINED AT SEATING PLANE -AC-.

 6. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.250 (0.010) PER SIDE. DIMENSIONS A AND B DO INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE -AB-.
- DO INCLUDE MOLD MISMAICH AND ARE
 DETERMINED AT DATUM PLANE AB-.

 7. DIMENSION D DOES NOT INCLUDE DAMBAR
 PROTRUSION. DAMBAR PROTRUSION SHALL
 NOT CAUSE THE D DIMENSION TO EXCEED
 0.520 (0.020).
- 8. MINIMUM SOLDER PLATE THICKNESS SHALL BE
- MINIMOMO SOLDER PLATE THICKNESS SHALL
 0.0076 (0.0003).
 EXACT SHAPE OF EACH CORNER MAY VARY
 FROM DEPICTION.

	MILLIN	IETERS	INCHES			
DIM	MIN MAX		MIN	MAX		
Α	7.000	BSC	0.276 BSC			
A1	3.500	BSC	0.138	BSC		
В	7.000	BSC	0.276	BSC		
B1	3.500	BSC	0.138	0.138 BSC		
С	1.400	1.600	0.055	0.063		
D	0.300	0.450	0.012	0.018		
Е	1.350	1.450	0.053	0.057		
F	0.300	0.400	0.012	0.016		
G	0.800	BSC	0.031 BSC			
Н	0.050	0.150	0.002	0.006		
J	0.090	0.200	0.004	0.008		
K	0.500	0.500 0.700		0.028		
M	12°	REF	12° REF			
N	0.090	0.160	0.004	0.006		
Р	0.400 BSC		0.016 BSC			
Q	1°	5°	1°	5°		
R	0.150	0.250	0.006	0.010		
S	9.000	BSC	0.354 BSC			
S1	4.500	BSC	0.177 BSC			
٧	9.000 BSC		0.354 BSC			
V1	4.500 BSC		0.177 BSC			
W	0.200	REF	0.008 REF			
Х	1.000	REF	0.039 REF			

Motorola reserves the right to make changes without further notice to any products herein. Motorola makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does Motorola assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation consequential or incidental damages. "Typical" parameters which may be provided in Motorola data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. Motorola does not convey any license under its patent rights nor the rights or others. Motorola products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the Motorola product could create a situation where personal injury or death may occur. Should Buyer purchase or use Motorola products for any such unintended or unauthorized application, Buyer shall indemnify and hold Motorola and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that Motorola was negligent regarding the design or manufacture of the part. Motorola and was negligent regarding the design or manufacture of the part. Motorola and are registered trademarks of Motorola, Inc. Motorola, Inc. is an Equal Opportunity/Affirmative Action Employer.

Mfax is a trademark of Motorola, Inc.

How to reach us:

USA/EUROPE/Locations Not Listed: Motorola Literature Distribution; P.O. Box 5405, Denver, Colorado 80217. 303–675–2140 or 1–800–441–2447

JAPAN: Nippon Motorola Ltd.: SPD, Strategic Planning Office, 4–32–1, Nishi–Gotanda, Shinagawa–ku, Tokyo 141, Japan. 81–3–5487–8488

Mfax™: RMFAX0@email.sps.mot.com - TOUCHTONE 602-244-6609 - US & Canada ONLY 1-800-774-1848

ASIA/PACIFIC: Motorola Semiconductors H.K. Ltd.; 8B Tai Ping Industrial Park, 51 Ting Kok Road, Tai Po, N.T., Hong Kong. 852–26629298

INTERNET: http://motorola.com/sps



MPC940/D